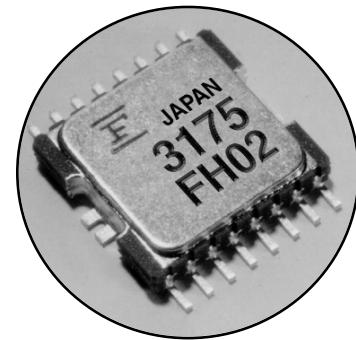


2.5Gb/s GaAs Laser Driver with Re-Timing Function

FMM3175VI

FEATURES

- Operation Speed Up to 2.5Gb/s, NRZ
- Built in D-FF (Re-timing and Bypass mode: Selectable)
- Peak Modulation Current with 25Ω load: 70mA (Min.)
- Bias Current: 70mA (Min.)
- Peak and Bias Current Adjustment
- ECL Compatible Input
- Single -5.2V Power Supply
- Duty Ratio Adjustment
- Output Shutdown Switch



DESCRIPTION

The FMM3175VI is a 2.5Gb/s(OC-48) laser driver with re-timing function. A D-FF is built in, and the re-timing and bypass mode are selectable using a selector(SEL) signal. The peak modulation currents are 70mA (Min.) with 25Ω load, and the bias current is available up to 70mA (Min.) the FMM3175VI also has a duty control circuit and an output shutdown switch.

ABSOLUTE MAXIMUM RATINGS (V_{DD} = 0V, Ta=25°C)

Parameter	Symbol	Ratings	Unit
Supply Voltage	V _{SS}	-7.0 to 0	V
Input Voltage	V _{IN}	V _{SS} to 0	V
Power Supply Current	I _{SS}	400	mA
Peak Current Control Voltage	V _{IP}	V _{SS} -2.0 to V _{SS} +1.5	V
Bias Current Control Voltage	V _{IB}	V _{SS} -2.0 to V _{SS} +2.1	V
Storage Temperature	T _{stg}	-55 to 125	°C

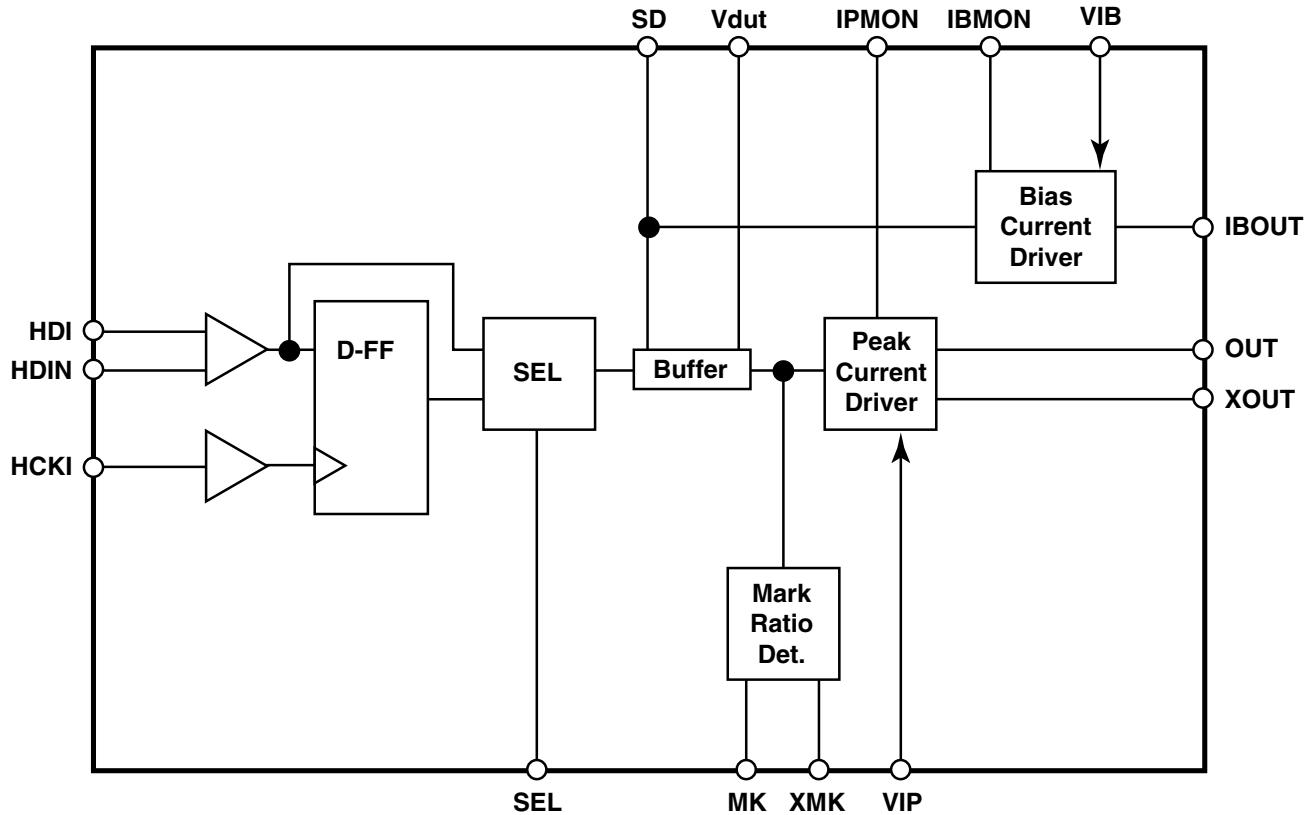
ELECTRICAL CHARACTERISTICS (Unless otherwise specified, T_c=25°C, V_{SS}=-5.2V, RL=25Ω)

Parameter	Symbol	Test Conditions	Limit			Unit
			Min.	Typ.	Max.	
Maximum Data Rate		NRZ	2.5	-	-	Gb/s
Modulation Current	I _P	V _{IP} = -4.1V, V _{IB} = -5.2V, HDI = "H"	70	80	-	mA
Modulation Current when Shutdown	I _{Ps} d	V _{IP} : Adjusted for 70mA, V _{IB} =-5.2V, HDI="H"	-	1.0	2.0	mA
Bias Current	I _B	V _{IB} = -3.4V, V _{IP} = -5.2V, SD = -1.7V	70	-	-	mA
Bias Current when Shutdown	I _B s _d	V _{IB} = -3.4V, V _{IP} = -5.2V, SD = -0.9V	-	1.0	2.0	mA
Power Supply Current	I _{SS}	V _{IP} = -5.2V, V _{IB} = -5.2V	100	160	260	mA
Rise Time	t _r	IP=70mA 20% to 80%	-	80	100	ps
Fall Time	t _f		-	80	100	ps
Duty Control Range	Duty	2.5Gb/s, IP=70mA, SEL="H"	90	-	110	%
Setup Time	T _s	SEL="H" (Re-timing mode)	-	60	100	ps
Hold Time	T _h		-	40	60	ps
Mark Density Monitor Output	MK	Rmk=1kΩ Cmk=1nF NRZ Duty=100 %	Mark Density	-	-	-
			100%	-1.85	-1.0	-0.80
			50%	-0.98	-0.50	-0.40
			0%	-0.10	-0.0	-
						V

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Test Conditions	Limit			Unit
			Min.	Typ.	Max.	
Supply Voltage	V _{SS}		-5.46	-5.20	-4.94	V
Input Level High	V _{IH}		-1.05	-0.90	-0.80	V
Input Level Low	V _{IL}		-2.00	-1.70	-1.55	V
Peak Current Control Voltage	V _{IP}		V _{SS}	-	V _{SS} +1.1	V
Bias Current Control Voltage	V _{IB}		V _{SS}	-	V _{SS} +1.8	V
Duty Control Voltage	V _{dut}		-1.80	-	-0.80	V
Case Temperature	T _C		0.0	-	+85	°C

FMM3175VI Block Diagram



OPERATION MODE

The "SEL" signal determines the operation mode between re-timing and bypass modes.
The truth table is as follows:

SEL	Operation mode
H	Re-timing (D-FF: active)
L	Bypass(D-FF: bypassed)

SHUTDOWN CONTROL

SD	Output Current
H	Disable
L	Enable

FUNCTION (Re-timing mode)

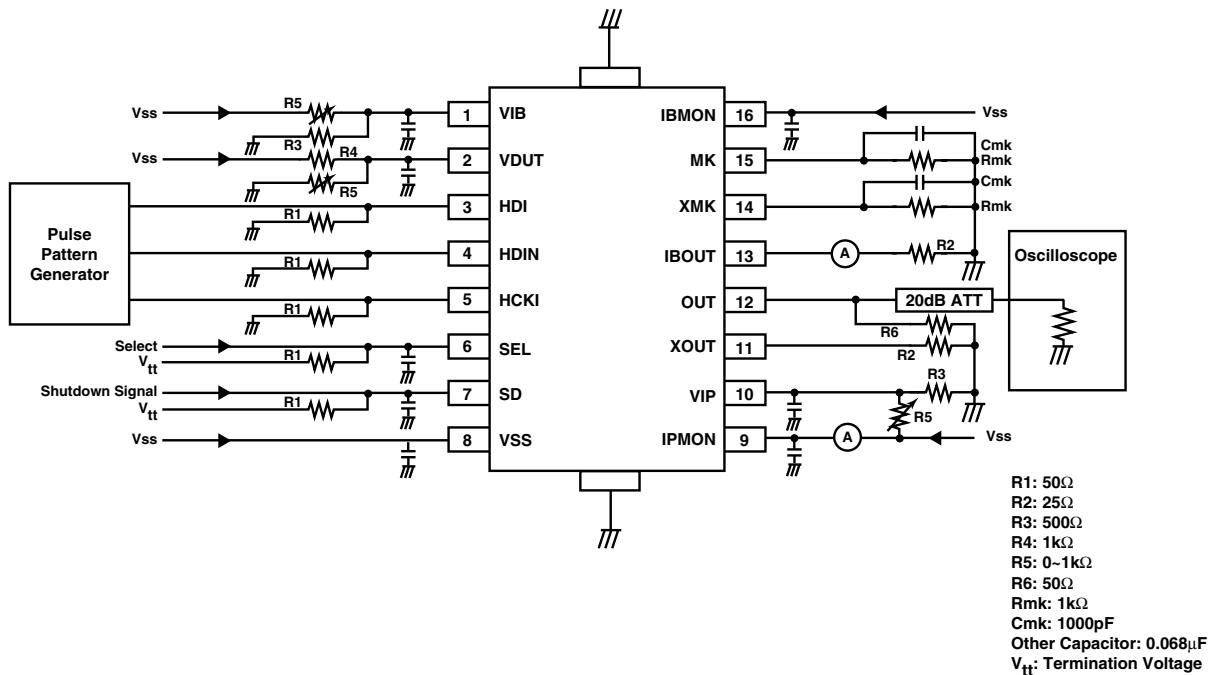
HDI(HDIN)	HCKI	OUT	XOUT
H(L)	↑	ON	OFF
L(H)	↑	OFF	ON
-	↓	Q	XQ

↑ : Positive Edge, ↓ : Negative Edge, Q/XQ: Hold Previous State

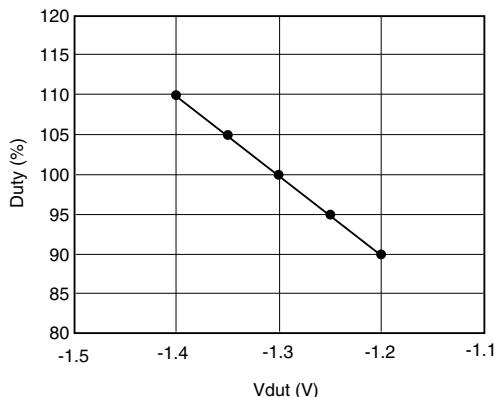
FUNCTION (Bypass mode)

HDI(HDIN)	HCKI	OUT	XOUT
H(L)	-	ON	OFF
L(H)	-	OFF	ON

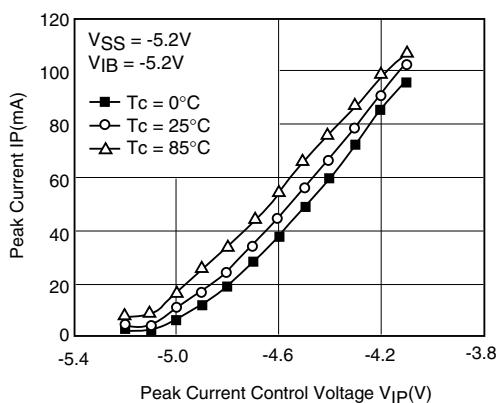
Test Circuit



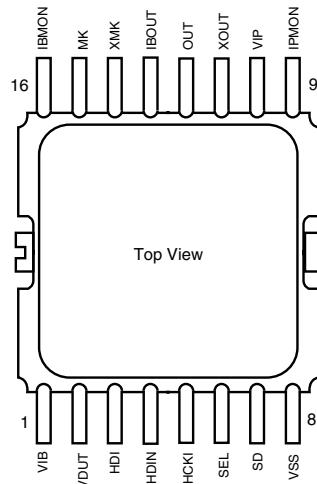
Output Duty Control Characteristics



Peak Current Control Characteristics



FMM3175VI Pin Assignment

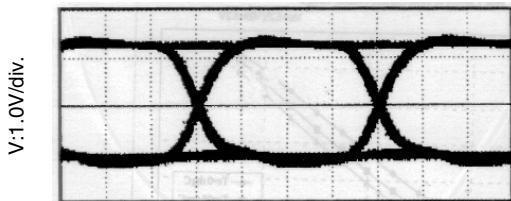


Pin Description

Pin Name	Pin No.	Description	Pin Name	Pin No.	Description
VIB	1	Bias Current Control Voltage	IPMON	9	Modulation Current Monitor (VSS:-5.2V)
VDUT	2	Output Duty Control Voltage	VIP	10	Modulation Current Control Voltage
HDI	3	Data Input (True)	XOUT	11	Modulation Current Output (Invert)
HDIN	4	Data Input (Invert)	OUT	12	Modulation Current Output (True)
HCKI	5	Clock Input	IBOUT	13	Bias Current Output
SEL	6	Operation Mode Selection	XMK	14	Mark Density Monitor Output (Invert)
SD	7	Output Current Shutdown Input	MK	15	Mark Density Monitor Output (True)
VSS	8	Supply Voltage	IBMON	16	Bias Current Monitor (VSS: -5.2V)

Ground Pin - Ground/
Heat Sink(Back Side) - Ground

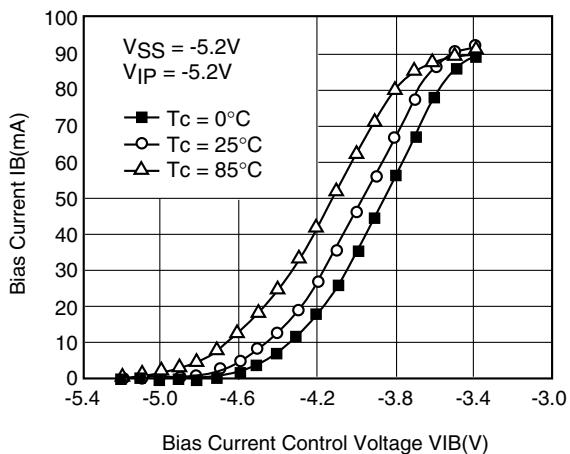
Output Waveform



H:100ps/div.

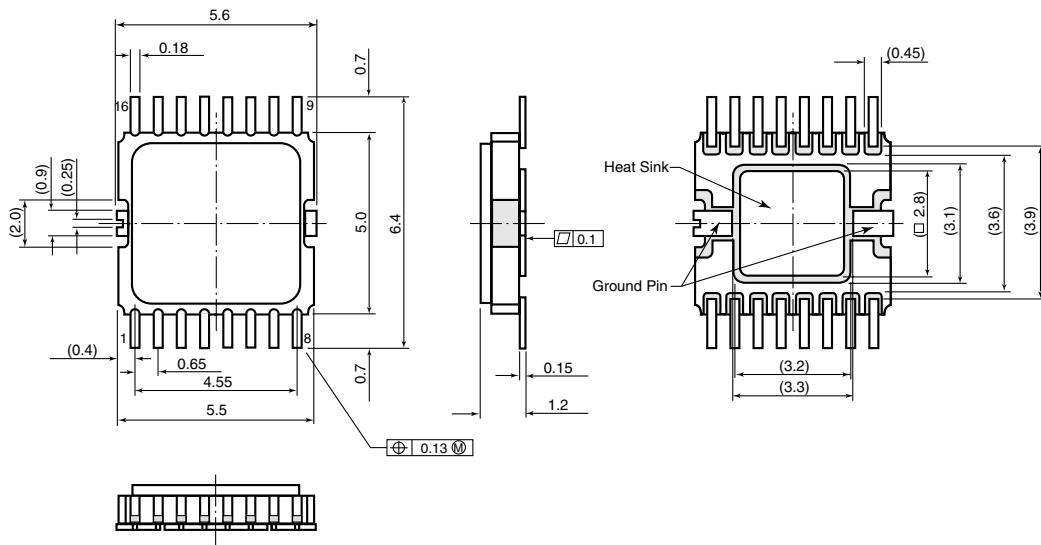
$f_b = 2.5\text{Gb/s}$
 $V_{SS} = -5.2\text{V}$, $T_c = 25^\circ\text{C}$
 $R_L = 25\Omega$

Bias Current vs. Bias Current Control Voltage



"VI" PACKAGE

UNIT: mm

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